

Application No. 10/537729
Response to the Office Action dated July 21, 2008

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Amendments to the Specification:

This listing of the paragraphs of the specification will replace all prior versions of the corresponding paragraphs of the specification in the application.

Listing of Amended Paragraphs of the Specification:

Please amend the paragraph beginning on page 7, lines 14 to read as follows:

The case 2 is made of a synthetic resin and has a lower surface on which the substrate 8 is mounted. As shown in Fig. 2, the case 2 includes a first space 21 for accommodating the light source unit 1. As shown in Figs. 2-4, the case 2 further includes a second space 22 for accommodating the sensor IC chips 7, and a third space 23 for accommodating the light guide 3 and the reflector 4. The first space 21 and the second space 22 are separated by a first partition wall 24 of the case 2 (See Fig. 2). The second space 22 ~~ad~~ and the third space 23 are separated by a second partition wall 25 (See Figs. 2 and 3). The second partition wall 25 is spaced from the substrate 8 and provided above the substrate. The first and the second partition walls 24 and 25 are provided to block the light directly traveling toward the sensor IC chips 7 from the light source unit 1. As shown in Fig. 3, the second partition wall 25 has a flat surface 25a extending parallel to the principal surface 81 of the substrate 8. The wire W enters between the flat surface 25a and the principal surface 81 of the substrate 8 at least partially.